

# Specification for Approval



Customer:	立创	
Customer P/N:	C328275	
Product Name:	Power Inductors	
Coilank P/N:	APD04T30M4R7	

 $[\boxtimes New Released, \Box Revised]$ 

Approved by	Checked by	Prepared by
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# Coilank Technology Co., Ltd

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【For C	ustomer approval Or	nly]	Date:			
Quali	fication Status:	🗌 Full	☐ F	Restricted		ejected
	Approved By	Verified	d By	Checke	ed By	]
Comme	ents:					- 

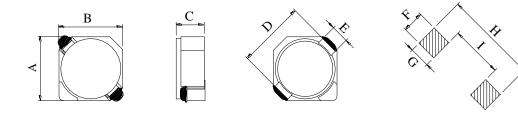


# **Change Note**

Version	Comtent	Draw	Check	Approval	Date	Coding
1	New Design	Bruce.lan	Jean.lin	Jean.lin	2019.04.18	S153



#### 1. External Dimensions (Unit:m/m)



Туре	Α	В	С	D	Е	F	G	Н	I	Q'TY/Reel
APD04T30	3.8±0.3	3.8±0.3	2.8±0.3	5.2Max	1.1Ref	1.5Ref	1.4Ref	5.2Ref	2.4Ref	2000

#### 2. Part Number Code

<u>AP</u>	D	<u>04</u>	<u>T</u>	<u>30</u>	M	<u>4R7</u>	
A		В	С	D	Е	F	
A:	Series	s Nam	ne		Р	ower Indu	uctors
B:	Dime	nsions	s(mm)	)	C	4: 3.8x3	8.8
C:	Mater	rials			٦	: T type	
D:	Thick	ness(	mm)		3	0: 2.8	
E:	Tolera	ance			N	l: ±20%	
F:	Induc	tance			4	R7=4.7uł	H

#### 3. Electrical Characteristics

Part Number	Inductance	Test Frequency	DC Resistance	Saturation Current
	(uH)	(KHz)	(mΩ)Max.	(A)Max.
APD04T30M4R7	4.7	100KHz/0.25V	88.0	1.65

#### Notes:

- 1) AEC-Q200 qualified.
- 2) All test data is referenced to 25  $^\circ\!\!\mathrm{C}$  ambient.
- 3) Operating temperature range -40℃ to +125℃.
- 4) Isat :DC current(A) that will cause lo to drop approximately 35%.
- 5) The part temperature(ambient + temp rise)should not exceed 125°C under worst case operating conditions. circuit design,component placement, PWB trace size and thickness,airflow and other cooling provisions all affect the part temperature,part temperature should be verified in the end application.



### 4. Test Data

E	LECTRICA	L CHARCTE	RISTIC	MECHANICAL DIMENSIONS				
SPEC	L(uH)	DCR(mΩ)	Isat(uH)	A(mm)	B(mm)	C(mm)	E(mm)	
TOL	4.7	88.0	1.65A	3.8	3.8	2.8	1.1	
NO	±20%	Max	(L0A-L1.65A) /L0A≤35%	±0.3	±0.3	±0.3	Ref	
1	4.58	62.24	3.63	4.04	4.03	2.87	ОК	
2	4.45	61.58	3.62	4.02	4.05	2.80	ОК	
3	4.54	61.26	3.55	4.02	4.01	2.87	ОК	
4	4.52	61.47	3.63	4.03	4.03	2.86	OK	
5	4.35	62.18	3.59	4.04	4.02	2.87	OK	
6	4.46	60.59	3.54	4.03	4.04	2.89	OK	
7	4.54	61.88	3.62	4.02	4.01	2.80	ОК	
8	4.35	61.07	3.56	4.06	4.06	2.88	ОК	
9	4.54	62.91	3.64	4.02	4.07	2.87	ОК	
10	4.42	62.37	3.61	4.01	4.02	2.81	OK	

# 5. Test and Measurement Procedures

#### 5.1 Test Conditions

- 5.1.1 Unless otherwise specified, the standard atmospheric conditions for measurement/test as:
  - a. Ambient Temperature: 20±15°C
  - b. Relative Humidity: 65%±20%
  - c. Air Pressure: 86KPa to 106KPa
- 5.1.2 If any doubt on the results, measurements/tests should be made within the following limits:
  - a. Ambient Temperature: 20±2°C
  - b. Relative Humidity: 65%±5%
  - c. Air Pressure: 86KPa to 106Kpa

#### 5.2 Visual Examination

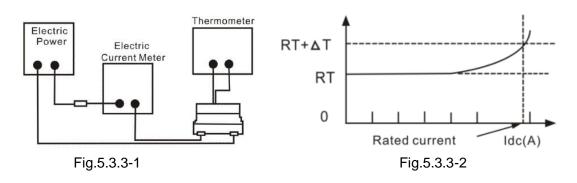
a. Inspection Equipment: 10X magnifier

#### 5.3 Electrical Test

- 5.3.1 Inductance (L)
  - a. Refer to the third item.
  - b. Test equipment: IM3536 LCR meter or equivalent.
  - c. Test Frequency and Voltage: Refer to the third item.
- 5.3.2 Direct Current Resistance (DCR)
  - a. Refer to the third item.
  - b. Test equipment: VR126 or equivalent.
- 5.3.3 Current
  - a. Refer to the third item.
  - b. Test equipment (see Fig.5.3.3-1): Electric Power, Electric current meter, Thermometer.
  - c. Measurement method (see Fig. 5.3.3-1):



- 1. Set test current to be 0 mA.
- 2. Measure initial temperature of chip surface.
- 3. Gradually increase voltage and measure chip temperature for corresponding current.
- d. Definition of Temperature rise current: DC current that causes the temperature rise ( $\Delta$  T =40°C) from 20°C ambient (see Fig. 5.3.3-2).



#### 5.4 Reliability Test

ltem	Specifications	Test conditions
5.4.1 High temperature storage test	No visible mechanical damage. Inductance change: Within ±10%.	Temperature: 125±2°C. Duration:1000hrs. Measured at room temperature after placing for 24±4 hrs. Temp 125°C High temperature 25°C 0°C 1000H Test Time
5.4.2 Temperature cycling test	No visible mechanical damage. Inductance change: Within ±10%.	Condition for 1 cycle. Step1 : $-40\pm2^{\circ}C$ 30min Min. Step2 : $125\pm2^{\circ}C$ , transition time 1min Max. Step3 : $125\pm2^{\circ}C$ 30min Min. Step4 : Low temp, transition time 1min Max. Number of cycles : 1000. Measured at room temperature after placing for 24±4 hrs. Temp 125°C 0°C -40°C
5.4.3 Biased humidity test	No visible mechanical damage. Inductance change: Within ±10%.	Humidity :85% $\pm$ 3 RH. Temperature : 85°C $\pm$ 2°C. Duration : 1000hrs. Measured at room temperature after placing for24 $\pm$ 4 hrs.

#### **Power Inductors**



ltem	Specifications	Test conditions
5.4.4 Operational life test	No visible mechanical damage. Inductance change: Within ±10%.	Temperature:105±2℃. Duration :1000hrs. Measured at room temperature after placing for24±4 hrs.
5.4.5 Resistance to solvent test	No visible mechanical damage. Inductance change: Within ±10%.	Add aqueous wash chemical - OKEM clean or equivalent.
5.4.6 Vibration test	No visible mechanical damage. Inductance change: Within ±10%.	Oscillation Frequency: 10~2K~10Hz for 20 minute. Total Amplitude:1.52mm±10%. Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations).
5.4.7 Resistance to soldering heat test	No visible mechanical damage. Inductance change: Within ±10%.	Temperature (°C): 260 ±5 (solder temp). Time (s): 10 ±1. ramp/immersion and emersion rate: 25mm/s ±6 mm/s. Number of heat cycles:1. 260°C 150°C 60 sec. $10\pm1$ sec.
5.4.8 Solderability test	More than 95% of the terminal electrode should be covered with solder.	Steam Aging: 8 hours $\pm$ 15 min. Preheat: 150°C,60sec. Solder: Sn99.5%-Cu0. 5%. Temperature: 245 $\pm$ 5°C. Flux for lead free: Rosin. 9.5%. Dip time: 4 $\pm$ 1sec. Depth: completely cover the termination. 245°C 150°C 60 60 4 $\pm$ 1 sec.
5.4.9 Terminal strength (SMD) test	No visible mechanical damage.	With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied radually as not to apply a shock to the component being tested.

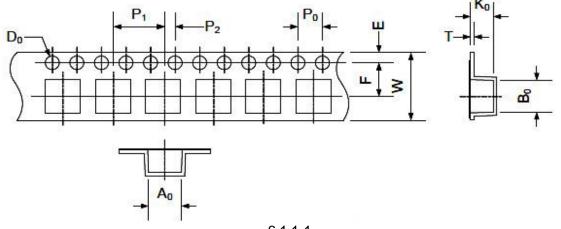
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## 6. Packaging, Storage

#### 6.1 Tape and Reel Packaging Dimensions

6.1 .1 Taping Dimensions (Unit: mm)

Please refer to Fig. 6.1.1-1



6.1.1-1

TYPE	A0	B0	W	Е	F	P0	P1	P2	Т	K0
APD04T30	4.5±0.1	4.5±0.1	12.0±0.3	1.75±0.1	5.5±0.1	4.0±0.1	8.0±0.1	2.0±0.1	0.4±0.1	3.4±0.1

6.1.2 Reel Dimensions (Unit: mm)

Please refer to Fig. 6.1.2-1.

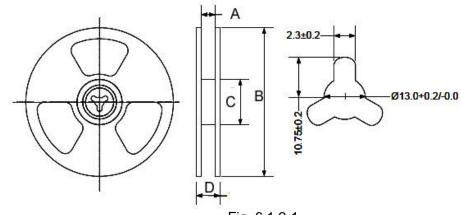


Fig. 6.1.2-1.

TYPE	А	В	С	D
APD04T30	12.5±2.0	330.0±2.0	100.0±2.0	16.5±2.0

#### **Power Inductors**



#### 6.2 Packaging

6.2.1 The inner box specification: 350\*340\*40MM

Packing quantity: 4000PCS/ box

Bubble bag : 37\*45CM

Job description: putting the air bubble bag products placed inside the box, sealed with scotch tape

6.2.2 the outside box specification: 370\*360\*255MM

Packing quantity: 20000PCS/ box

Job description: will be outside the box bottom

sealed, inner box into the box.

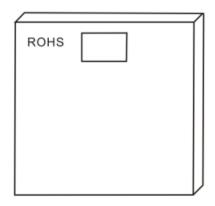
a. with transparent tape sealed box at the top

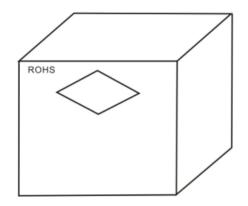
b. the specified location with a box labels in the outer box.

c.if the mantissa box under a FCL with inner box or filling full

## 6.3 Storage

- a.To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
- b. Recommended conditions: -10 °C ~40 °C, 70%RH (Max.)
- c.The ambient temperature must be kept below 30℃.Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used with one year from the time of delivery.
- d. In case of storage over 6 months, solderability shall be checked before actual usage.



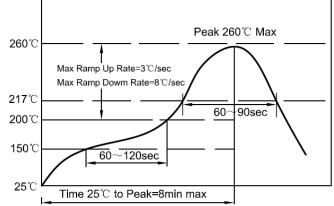


## 7. Recommended Soldering Technologies

7.1 Re-flowing Profile:

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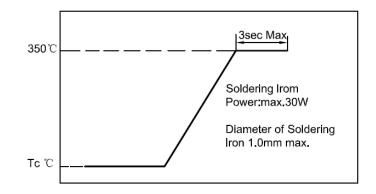
- $\triangle$  Preheat condition: 150~200°C/60~120sec.
- $\triangle$  Allowed time above 217°C: 60~90sec.
- $\triangle$  Max temp: 260°C
- $\triangle$  Max time at max temp: 5sec.
- $\triangle$  Solder paste: Sn/3.0Ag/0.5Cu
- $\bigtriangleup\,$  Allowed Reflow time: 2x max



#### 7.2 Iron Soldering Profile:

- △ Iron soldering power: Max.30W
- $\triangle$  Pre-heating: 150°C/60sec.
- $\triangle$  Soldering Tip temperature: 350 °C Max.
- △ Soldering time: 3sec Max.
- △ Solder paste: Sn/3.0Ag/0.5Cu
- △ Max.1 times for iron soldering

[Note: Take care not to apply the tip of the soldering iron to the]



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